

GUIDED SELF-ASSEMBLY OF BLOCK COPOLYMER FILMS ON INTERFEROMETRICALLY NANOPATTERNED SUBSTRATES

STATEMENT OF GOVERNMENT RIGHTS

[0001] This invention was made with United States government support awarded by the following agency: NSF 9708944. The United States government has certain rights in this invention.

CROSS-REFERENCE TO RELATED APPLICATION

[0002] This application is a divisional of application Serial No. 09/971,442, filed October 5, 2001, the disclosure of which is incorporated herein by reference.

FIELD OF THE INVENTION

[0003] This invention pertains generally to the field of nanofabrication techniques and particularly to nanofabrication carried out utilizing diblock copolymers.

BACKGROUND OF THE INVENTION

[0004] Significant challenges are encountered in the fabrication of nanostructures, particularly structures at a length scale of 10 nm to 50 nm. It is possible to fabricate isolated or semi-dense structures at this scale with an advanced lithographic technique such as electron beam lithography, but the exposure tools are extremely expensive and optimization of photo-resist processing is non-trivial and may not be amenable to strict control of dimensions or roughness.

[0005] New processes and novel materials are required to make nanofabrication easier, cheaper, and more versatile. Block copolymers are interesting materials for use in nanofabrication because they microphase separate to form ordered, chemically distinct domains with dimensions of 10's of nm. The size and shape of these domains can be controlled by manipulating the molecular weight and composition of the copolymer. Additionally, the interfaces between these domains have widths on the order of 1-5 nm and can be controlled by changing the chemical composition of the blocks of the copolymers. An advantage of using block copolymer systems as templates is that linewidth, tolerances and margins, and line edge roughness are dictated by thermodynamics (molecular weight, the Flory-Huggins interaction parameters χ between the blocks of the copolymer). It is unclear whether standard resist processing, where performance depends on control of kinetic processes, will be applicable at the scale of 10's of nm.

[0006] The feasibility of using thin films of block copolymers as templates was demonstrated previously by Chaikin and Register, et al., Science 276, 1401 (1997). Dense arrays of dots and holes with dimensions of 20 nm were transferred from a thin film of poly(styrene-*b*-isoprene) to silicon nitride substrates. The perfection of ordering of domains extend over grain sizes of approximately $1 \mu\text{m}^2$. For many applications, macroscopic orientation of the copolymer domains over areas as large as several cm^2 and registration of the domains with the substrate will be required. Thin films with macroscopically ordered domains are envisioned as having potential in several applications including nanowires, magnetic storage media, quantum devices, and photonic crystals. Strategies for inducing macroscopic orientation of

copolymer domains in thin films have included: (1) the use of electric fields to orient cylindrical domains in asymmetric diblock copolymer films both parallel to the film along electric field lines and perpendicular to the film in hexagonal arrays, (2) the use of miscut silicon wafers as substrates to align thickness induced morphologies along the corrugations of the substrate, (3) the use of miscut silicon wafers with obliquely deposited Au stripes to promote alternating wetting of the blocks on the alternating Si and Au stripes and perpendicular orientation of lamellar domains, and (4) the use of sidewall constraints to induce long range ordering of spherical domains in asymmetric diblock copolymers.

[0007] One approach to inducing macroscopic orientation of the domains of block copolymers combines advanced lithographic techniques and the self-assembly of the block copolymer film. Organic imaging layers are patterned using lithographic tools, e.g., proximity x-ray lithography with a mask and extreme ultraviolet (EUV) interferometric lithography. Regions of the imaging layer that are exposed to radiation or electrons undergo a chemical transformation that alters the surface chemistry of the imaging layer. A thin film of a symmetric diblock copolymer is then deposited on the patterned imaging layer and annealed above the glass transition temperature of the blocks of the copolymer. During annealing, the lamellar domains of the copolymer film self-assemble such that adjacent regions of the chemically patterned surface are wet by the different blocks of the copolymer. The lamellae orient perpendicular to the plane of the film and amplify the surface pattern. After annealing, selective removal of one of the blocks results in a nanopatterned template that can be used for additive or subtractive processes for nanofabrication. This strategy has the advantages of

achieving macroscopic orientation of the lamellar domains using parallel exposure tools and registration of the patterned film with the substrate. See, Richard D. Peters, et al., "Using Self-Assembled Monolayers Exposed to X-Rays to Control the Wetting Behavior of Thin Films of Diblock Copolymers," *Langmuir*, Vol. 16, 2000 (published on web 04/07/2000), pp. 4625-4631; Qiang Wang, et al., "Symmetric Diblock Copolymer Thin Films Confined Between Homogenous and Patterned Surfaces: Simulations and Theory," *Journal of Chemical Physics*, Vol. 112, No. 22, 8 June 2000, pp. 9996-10010; Tae K. Kim, et al., "Chemical Modification of Self-Assembled Monolayers by Exposure to Soft X-Ray in Air," *J. Phys. Chem. B.*, Vol. 104, 2000 (published on web 07/18/2000), pp. 7403-7410.

SUMMARY OF THE INVENTION

[0008] In the present invention, advanced interferometric lithography is combined with self-assembled block copolymer systems to provide nanofabricated structures. Interferometry is used to pattern substrates with regions of different chemical functionality in spatial arrangements commensurate with the characteristic dimensions of the domain structure of the polymer. Upon ordering, the morphology of a block copolymer layer on the surface of the substrate is guided toward the desired long-range orientation, amplifying the pattern on the surface. The block copolymers can be synthesized for guided self-assembly and either are functional as formed or can be functionalized after microstructures are formed.

[0009] In forming the copolymer microstructures in accordance with the invention, a substrate is provided with an imaging layer thereon

that will respond to exposure to selected wavelengths to change the wettability of the exposed material of the imaging layer to the components of a selected block copolymer. The imaging layer is then exposed to two or more beams of radiation within the selected wavelengths to form interference patterns at the imaging layer to change the wettability of the imaging layer in accordance with the interference patterns. Preferably, the interference pattern in the imaging layer has a period substantially equal to, and preferably within 20% of, the bulk lamellar period L_0 of the selected copolymer. For interference patterns having periods in the range of 10-100 nm, the exposing radiation preferably is at selected wavelengths in the extreme ultraviolet or shorter. A layer of the selected copolymer is then deposited onto the exposed imaging layer, and the copolymer layer is annealed to separate the components of the copolymer in accordance with the pattern of wettability in the underlying imaging layer to replicate the pattern of the imaging layer in the copolymer layer. For example, one of the beams may be provided directly from the source onto the imaging layer and the other beam may be provided by reflecting a portion of the beam from the same source with a Lloyd's mirror onto the imaging layer at an angle to the beam that is directly incident on the imaging layer. Where two such beams are utilized, the resulting pattern in the imaging layer defined by the interference pattern is a periodic pattern of alternating stripes which differ in wettability with respect to one of the components of the copolymer. The resulting microstructure in the annealed copolymer layer can comprise corresponding alternating stripes of the two components of the copolymer that are separated in accordance with the regions of greater or lesser wettability. Other interferometric processes and instruments may also be utilized.

[0010] A third beam may be provided to the imaging layer by reflecting a portion of the beam from the same source with another Lloyd's mirror onto the imaging layer at an angle to the beam that is directly incident on the imaging layer. The two Lloyd's mirrors are positioned at an angle to each other to provide interference patterns at the imaging layer that are at an angle to each other. In this manner, an array of separated regions can be defined in the imaging layer in which the separated regions have a higher or lower wettability with respect to one of the components of the copolymer. Deposit of the copolymer layer and annealing of the copolymer layer results in regions of one of the components of the copolymer separated primarily by components of the other copolymer in a pattern which corresponds to the underlying pattern in the imaging layer. The imaging layer may be formed of materials such as self-assembled monolayers such as alkylsiloxanes. Various block copolymers may be utilized, one example of which is a copolymer of polystyrene and poly(methyl methacrylate).

[0011] Further objects, features and advantages of the invention will be apparent from the following detailed description when taken in conjunction with the accompanying drawings.

BRIEF DESCRIPTION OF THE DRAWINGS

[0012] In the drawings:

[0013] Fig. 1 is a phase diagram of equilibrium film morphologies for symmetric diblock copolymer films confined between patterned and neutral surfaces.

[0014] Fig. 2 is a diagram of interfacial energy between self-assembled monolayers of OTS exposed at different doses and a copolymer of polystyrene and poly(methyl methacrylate).

[0015] Fig. 3 is an illustrative diagram of calculated extreme ultraviolet intensity at a sample surface utilizing multiple interfering beams.

[0016] Fig. 4 is a simplified diagram illustrating the steps in forming of copolymer structures in accordance with the invention.

[0017] Fig. 5 is a simplified view of an exposure pattern formed on a substrate by three interfering beams.

[0018] Fig. 6 is a simplified diagram illustrating the stripe pattern of illumination at the surface of a substrate from two interfering beams.

[0019] Fig. 7 are plots showing the one-dimensional order parameter profiles for different values of ω_{sA} with $\alpha_{sA} = -0.2$.

[0020] Fig. 8 are graphs illustrating the one-dimensional order parameter profiles for different values of α_{sA} with $\omega_{sA} = 9$.

[0021] Fig. 9 are contour plots of the two-dimensional order parameter profiles for the morphology between a lower hexagonally patterned substrate and an upper sH surface.

[0022] Fig. 10 is a schematic diagram of an interferometric lithography system that may be utilized to expose samples in a pattern in accordance with the invention.

DETAILED DESCRIPTION OF THE INVENTION

[0023] In the present invention, thin films of block copolymer are self-assembled to produce structures that may be used, e.g., as templates for nanofabrication under appropriately controlled conditions. Processing conditions are preferably utilized that induce perpendicular orientation of the microphase separated domains and amplification of the surface patterns that are lithographically formed on a substrate. The following discusses the factors that influence the preferred processing conditions.

[0024] The free energy of symmetric diblock copolymer films confined between homogeneous and patterned surfaces is assumed to consist of four contributions: (1) the elastic free energy associated with chain stretching, (2) the block-block interfacial energy, (3) the surface-block interfacial energy, and (4) the free energy of bending if the lamellae were not flat. The equilibrium film morphology was determined from proposed structures with the minimum total free energy, and is found to be primarily a result of the competition between unfavorable surface-block interactions and chain stretching. Monte Carlo simulations were used that generated all possible structures, and the results allowed the construction of a phase diagram, as shown in Fig. 1, of equilibrium film morphologies as a function of the film thickness, the period of the pattern on the substrate, the bulk lamellae period L_0 of the polymer, and the interaction potentials of the individual blocks of the polymer with the bounding surfaces. This figure shows a phase diagram of equilibrium film morphologies for symmetric diblock copolymer films confined between patterned and neutral surfaces. The abscissa is the ratio of pattern period to lamellar period, and the ordinate is the ratio of film thickness to lamellar period. Symbols represent Monte Carlo results, and lines

represent results from calculations from the phenomenological model. Schematics (a) through (e) are representations of the film morphology in each region of the phase diagram, where light regions represent one block and dark regions represent the other block. The surface pattern is designated by alternating sA and sB regions. Schematic (d) represents the desired film morphology with perpendicular orientation of lamellae that amplify the surface pattern. The optimal conditions that resulted in perpendicular lamellae that amplified the surface were found to be (1) the period of the substrate pattern equaled the bulk period of the lamellar domains (L_0), (2) the upper surface of the film was near neutral wetting conditions (had equal affinity for both blocks of the copolymer), and (3) the film thickness was equal to or less than L_0 . Slight deviations from these optimal conditions, e.g., the upper surface had a slight affinity for one of the blocks or the film thickness was greater than L_0 , still resulted in the desired behavior.

[0025] Imaging layers were developed to meet the following criteria: (1) the surface chemistry must be tunable by interferometric techniques such that exposed and unexposed regions have different affinities (wetting) for the blocks of the copolymer, and (2) the layers must be thermally stable during a high temperature annealing of the polymer films. Self assembled monolayers (SAMs) of alkylsiloxanes are suitable as imaging layers because: (1) the surface chemistry of SAMs of alkylsiloxanes on SiO_x can be modified by suitable exposure (e.g., to x-rays in the presence of air), (2) SAMs are ultrathin layers (2.6 nm) (eliminating opacity issues for extreme ultraviolet (EUV) lithography), and (3) SAMs of alkylsiloxanes are thermally stable under vacuum up to temperatures of 740 K. Chemical modification of a CH_3 -terminated SAM

of octadecyltrichlorosilane (OTS) occurs and photoelectrons are emitted from the substrate upon irradiation with, e.g., x-rays. These photoelectrons produce radicals at the surface of the SAM. The surface radicals react with oxygen in the exposure atmosphere to produce hydroperoxy radicals or undergo recombination or crosslinking reactions. The hydroperoxy radicals decompose to form hydroxyl, aldehyde, and carboxylic acid groups on the surface of the SAM. The selectivity of the reaction for production of hydroperoxy radicals versus recombination/crosslinking reactions depends upon the pressure of oxygen in the exposure atmosphere, and this competition between reactions results in asymptotic conversion of the CH₃ groups to polar, oxygen containing groups, with the asymptotic limit also being a function of the pressure of oxygen.

[0026] The wetting behavior of block copolymer thin films has been shown to depend upon the interfacial energy between each block of the copolymer and the substrate, with the block having the lower interfacial energy preferentially wetting the substrate. The interfacial energies (γ) between polystyrene (PS) and poly(methyl methacrylate) (PMMA) and SAMs of OTS exposed to x-rays in air was calculated as a function of dose as shown in Fig. 2, and the wetting behavior of thin films of poly(styrene-*b*-methyl methacrylate) (P(S-*b*-MMA)) was described qualitatively at each dose. Unexposed SAMs of OTS were dewet by films of P(S-*b*-MMA) because the spreading coefficient was less than 0. The polymer films wet SAMs of OTS with the PS block present at the substrate interface for exposure doses between 300 and 1000 mJ/cm² because $\gamma_{PS/OTS}$ was lower than $\gamma_{PMMA/OTS}$. At a dose of 1200 mJ/cm², $\gamma_{PS/OTS} = \gamma_{PMMA/OTS} = 0$, and the surfaces were neutral such that the

lamellae oriented perpendicular to the substrate. For doses greater than 1400 mJ/cm^2 , $\gamma_{\text{PMMA/OTS}} < \gamma_{\text{PS/OTS}}$, and the PMMA block preferentially wets the substrate. SAMs of alkylsiloxanes were concluded to be suitable imaging layers: (1) SAMs of OTS exposed to low doses of x-rays in air (between 300 and 500 mJ/cm^2) are wet by the PS block of P(S-*b*-MMA) films, (2) SAMs of OTS exposed to high doses of x-rays in air (greater than 1400 mJ/cm^2) are converted to polar surfaces that are preferentially wet by the PMMA block of P(S-*b*-MMA) films. Therefore, SAMs of OTS meet the criterion that exposed and unexposed (or lightly exposed) regions are wet by the different blocks of the copolymer.

[0027] The requirements for the exposure system under preferred conditions are: (1) capability to pattern at the scale of L_0 (10-100 nm), and (2) ability to pattern over large areas in a parallel process. EUV, proximity x-rays, and electron beam lithography are capable of patterning at the scale of L_0 , but only EUV and proximity x-ray lithography are parallel techniques. Proximity x-ray lithography is limited by the difficulty of fabricating masks with dense features with periods at the scale of L_0 . EUV lithography is advantageous compared to x-ray lithography because the mean free path of the photoelectrons produced by photons absorbed in the substrate is minimized for EUV radiation (e.g., $\lambda = 13.4 \text{ nm}$). The imaging layer undergoes chemical transformation as a result of the photoelectrons emitted from the substrate during irradiation. This minimum in the photoelectron energy reduces the lateral spreading of the photoelectrons and results in higher fidelity in pattern transfer to the imaging layer. Information regarding the chemical modification of SAMs of OTS with EUV radiation is not known to the same detail as for x-rays, but exposure of SAMs of OTS to high doses of EUV radiation in air results

in similar changes in surface properties such that these surfaces are wet by the PMMA block of P(S-*b*-MMA) films.

[0028] The present invention carries out lithography to pattern at the scale of L_0 utilizing interferometric techniques. An exemplary lithography system in accordance with the present invention is an EUV lithographic system utilizing a Lloyd's mirror interferometer to produce high density fringes. Part of the incident beam is reflected from the Lloyd's mirror at a grazing angle and interferes with the direct beam at the plane of the substrate. Such a system is capable of producing grating patterns with very small periods, on the order of 10's of nm. Suitable EUV radiation can be obtained from various sources, including synchrotrons. For a general comparison of presently available EUV sources, see V.Y. Banine, et al., "Comparison of Extreme Ultraviolet Sources for Lithography Applications," *Microelectronic Engineering*, Vol. 53, 2000, pp. 681-684. Although the present invention is exemplified below utilizing EUV interferometric lithography, it is understood that suitable nano-dimensioned interference patterns may be formed utilizing radiation at longer wavelengths. The following papers discuss examples of techniques that may be utilized to form nano-interference patterns: T.A. Savas, et al., "Achromatic Interferometric Lithography for 100-nm-Period Gratings," *J. Vac. Sci. Technol. B.*, Vol. 13, No. 6, Nov./Dec., 1995, pp. 2732-2735; Xiaolen Chen, et al., "Interferometric Lithography of Sub-Micrometer Sparse Hole Arrays for Field-Emission Display Applications," *J. Vac. Sci. Technol. B.*, Vol. 14, No. 5, Sep./Oct., 1996, pp. 3339-3349; T.A. Savas, et al., "Large-Area Achromatic Interferometric Lithography for 100 nm Period Gratings and Grids," *J. Vac. Sci. Technol. B*, Vol. 14, No. 6, Nov./Dec., 1996, pp. 4167-4170;

Wieland Schollkopf, et al., "A Cluster Size Nanofilter with Variable Openings Between 2 and 50 nm," J. of Chemical Physics, Vol. 109, No. 21, 1 Dec. 1998, pp. 9252-9257; J.A. Hoffnagle, et al., "Liquid Immersion Deep Ultraviolet Interferometric Lithography," J. Vac. Sci. Technol. B, Vol. 17, No. 6, Nov./Dec., 1999, pp. 3306-3309; M. Switkes, et al., "Patterning of Sub-50 nm Dense Features with Space-Invariant 157 nm Interference Lithography," Applied Physics Letters, Vol. 77, No. 20, 13 Nov. 2000, pp. 3149-3151.

[0029] The wetting behavior and morphology of thin films of P(S-*b*-MMA) on surfaces nanopatterned using EUV interferometric lithography were studied as a function of the commensurability between pattern period and lamellar period. For example, a film of P(S-*b*-MMA) was deposited on a surface patterned with a period of L_0 ($L_0 = 60\text{nm}$) using EUV interferometric lithography. The film thickness was about equal to L_0 . TEM images were obtained with staining of the PS block with RuO_4 , so that the PS block appears darker than the PMMA block, and confirm a perpendicular orientation of lamellae, with the lamellae amplifying the surface pattern. The lamellae were ordered over distances of several micrometers. The experimental conditions were very similar to the optimal conditions determined by simulations: (1) the pattern period substantially equaled L_0 , and (2) the film thickness was $\leq L_0$. The condition of neutral upper surface varied slightly in that the free surface of the film was slightly preferential to the PS block. In addition, the upper surface was a free surface compared to a confined surface in the simulations.

[0030] It is understood that many other block copolymers may be utilized. By way of example only, these include poly(styrene-b-isoprene), poly(styrene-b-butadiene), and poly(styrene-b-vinylpyridine).

[0031] As discussed above, interferometric patterning is well suited for preparing substrates to guide the self-assembly of lamellar and cylindrical morphologies because the interference patterns and the block copolymer morphologies exhibit the same symmetry. In accordance with the invention, crossing two coherent beams of light or using an interferometer such as a Lloyd's mirror interferometer results in alternating constructive and destructive interference "stripes" to guide the self-assembly of lamellar domains. Double exposure of stripes with an included angle of 120° , or intersecting three equally spaced beams of light, results in patterns with six-fold symmetry, or spots of constructive interference in a hexagonal array, which are utilized for guiding the self-assembly of cylindrical domains. For example, two Lloyd's mirrors can be mounted with an included angle between them of 120° . The EUV beam illuminates the edge region, thus being reflected by both mirrors. This defines three sources (two virtual and one real, the direct beam). The superposition of the tri-fold symmetric fields creates a triangular exposure pattern of sharp "dots" at the substrate plane, mounted perpendicularly to the symmetry axis of the system. The Lloyd's mirror system design is very tolerant of alignment. The lattice constant of the three-fold pattern can be easily changed by adjusting the incidence angle of the incoming beam. It is also important to notice that where the maxima of the fringes overlap, a bright spot is formed with an intensity equal to nine times that of the incoming beam. The type of pattern obtained is shown in Fig. 3. The interferometer preferably is integrated in a small volume, in order to

increase stiffness and minimize vibrations. Piezoelectric actuators may be used to align and maintain the alignment of the mirrors. A similar arrangement can be implemented with two mirrors at 90°, yielding a rectangular pattern. The process is carried out as illustrated in Fig. 4. A substrate 10 has an imaging layer 11 formed thereon that is patterned with EUV as described above. The resulting patterned imaging layer 13 is then covered with a layer of a selected block copolymer 15, and the copolymer layer is then annealed to form an array of self-assembled separated domains 17 of one polymer that are surrounded by the other polymer 18. Selective functionalization of the patterned structure may then be carried out, e.g., by etching out or otherwise removing the polymer in the domains 17 and filling the openings with another material, for example, a metal such as copper or nickel or a conducting polymer to form cells 20. The individual cells 20 formed in this manner may be characterized in various ways, such as by the use of a scanning probe 22 as shown in Fig. 4.

[0032] The following discusses the morphology of thin films of asymmetric (cylinder-forming) diblock copolymers on nano-patterned substrates. Monte Carlo simulations were used to avoid the assumptions implicit in theoretical work. If the substrate is patterned with an array, (e.g., a hexagonal array) of regions as shown in Fig. 5 that are preferentially wet by the minority component of the block copolymer, and the period of the surface pattern is commensurate with the period in the imaging layer, then the cylindrical domains in the block copolymer film will orient perpendicular to the substrate and amplify the surface pattern throughout the thickness of the film with long-range order. Perpendicular orientation and long-range order of hexagonally packed cylinders in the

film can also occur on striped surfaces of the type as shown in Fig. 6, with appropriate pattern dimensions and strengths of molecular level interactions between the polymer and the substrate over which these desirable configurations are achieved.

[0033] To analyze such systems, Monte Carlo simulations were performed in an expanded grand-canonical ensemble in the framework of a cubic lattice. Rectangular simulation boxes of dimensions L_x , L_y and L_z were employed. Asymmetric diblock copolymers with chain length $N = 36$ and a volume fraction of the shorter (denoted by A) blocks $f_A = 1/4$ are confined between two hard and flat surfaces perpendicular to the z direction. Periodic boundary conditions are applied in the x and y directions. We set the reduced temperature to $T^* \equiv k_B T / \epsilon_{A-B} = 1.5$, where k_B is Boltzmann's constant, T is the absolute temperature, and $\epsilon_{A-B} > 0$ is the repulsive interaction energy between non-bonded nearest-neighbor A-B pairs. We also set the reduced chemical potential to $\mu^* \equiv \mu / (k_B T) = 46$, where μ is the chemical potential of the system. (The ODT temperature of our system is estimated to be around $T^* = 3.0$ at this chemical potential.) Under these conditions, the asymmetric diblock copolymers form hexagonally packed cylinders in the bulk, with an intercylinder distance $L_0 \approx 16.8$ (in units of lattice spacing). In our model, one lattice unit represents one Kuhn segment of a real polymer chain (which is about 0.5~0.7 nm for flexible polymers such as polystyrene); our system is therefore in the range of molecular weights that are suitable for lithographic processes.

[0034] The upper surface is homogenous (denoted by sH). To facilitate the formation of perpendicular cylinders, we introduce a slight

preference by the upper surface for the longer (B) blocks, i.e., $\epsilon_{A-sH}/\epsilon_{A-sB} = 0.2$ and $\epsilon_{B-sH} = 0$. This energetic preference balances the slight entropic preference for the shorter (A) blocks exhibited by a hard and flat surface.

[0035] The lower substrate is chemically nano-patterned. The pattern period is set to $L_s = 14(\approx \sqrt{3}L_0/2)$, and the dark stripes are set to strongly prefer the B blocks (denoted by sB), i.e., $\epsilon_{A-sB}/\epsilon_{A-sA} = 2$ and $\epsilon_{B-sB} = 0$. The film thickness is fixed at $D = 28(\approx \sqrt{3}L_0)$; this distance is commensurate with parallel orientation of cylinders having bulk dimensions if such a morphology occurs. We also set $L_x = 67(\approx 4L_0)$. The morphological dependence of the thin films on the width ω_{sA} and the preference $\alpha_{sA} \equiv (\epsilon_{B-sA} - \epsilon_{A-sA}) / \epsilon_{A-sB}$ of the light stripes (denoted by sA) were then stacked. When the sA stripes energetically prefer A blocks ($\alpha_{sA} > 0$), we set $\epsilon_{A-sA} = 0$; when they prefer B blocks ($\alpha_{sA} < 0$), we set $\epsilon_{B-sA} = 0$.

[0036] Contour plots were made of the two-dimensional order parameter profiles $\langle \rho_A(x, y) - \rho_B(x, y) \rangle$ and $\langle \rho_A(y, z) - \rho_B(y, z) \rangle$ for the morphology that arises between a lower stripe-patterned substrate and an upper sH surface; here $\rho_A(x, y)$, for example, is the function of lattice sites occupied by the A segments at a given (x, y) and $\langle \rangle$ represents the average over the z direction for each collected configuration, and then over all collected configurations (at equilibrium). Such ensemble-averaged profiles are more meaningful and conclusive for characterization of different morphologies than visual inspection of a few snapshots of the system configuration. In this case, we set $\omega_{sA} = 9$, which is

commensurate with the diameter of cylinders in the bulk, and set $\alpha_{sA} = -0.2$ (the same preference as the upper sH surface). Perpendicular cylinders are formed throughout the entire film, and are located on the light stripes. Due to the staggered packing of cylinder layers (in the x-z plane), $\langle \rho_A(x, z) - \rho_B(x, z) \rangle$ only exhibits small variations around -0.35 , which is consistent with the average density (fraction of occupied lattice sites) $\langle \rho \rangle \approx 0.7$ of copolymers in our simulations. (Such a density corresponds to highly concentrated solutions or melts of copolymers.).

[0037] For the stripe patterns, there is translational symmetry along the x direction; since there is no preferred location of cylinders along the x direction, the perpendicular cylinders can oscillate along this direction during the course of a simulation run. Each “instantaneous” configuration collected after equilibration shows well-ordered, hexagonally packed perpendicular cylinders. It is anticipated that the “grain” size in this case is larger than that obtained by the use of a homogeneous substrate, i.e., the long-range ordering of perpendicular cylinders can be obtained by the use of a stripe-patterned substrate.

[0038] Similar perpendicular cylinders can be obtained within a large range of ω_{sA} , as long as $\alpha_{sA} = -0.2$. Fig. 7 shows the one-dimensional order parameter profiles $\langle \rho_A(z) - \rho_B(z) \rangle$ for different values of ω_{sA} with $\alpha_{sA} = -0.2$. the shape of $\langle \rho_A(z) - \rho_B(z) \rangle$ reflects the undulation of A-B interfaces in the perpendicular cylinders. However, there is only a small “window” of α_{sA} for obtaining such perpendicular cylinders. Fig. 8 shows $\langle \rho_A(z) - \rho_B(z) \rangle$ for different values of α_{sA} with $\omega_{sA} = 9$. A relatively strong preference for the longer (B) blocks ($\alpha_{sA} = -1$) leads to two layers of

parallel cylinders. On the other hand, even a weak preference for the shorter (A) blocks ($\alpha_{sA} = 0.5$) results in one layer of half-cylinders parallel to the surfaces and registered with the strip-pattern. Contour plots of the two-dimensional order parameter profiles $\langle \rho_A(x, y) - \rho_B(x, y) \rangle$ and $\langle \rho_A(y, z) - \rho_B(y, z) \rangle$ for a stronger preference for the A blocks, $\alpha_{sA} = 1$, show another layer of parallel cylinders staggered with respect to a layer of half-cylinders. In this case, the intercylinder distance (in the plane parallel to the surfaces) is 14, smaller than L_0 . Such a frustration may, in addition to the upper sH surface, facilitate the formation of perpendicular cylinders near the upper surface, where bulk dimensions are achieved.

[0039] With EUV-IL, a hexagonally patterned substrate, as shown in Fig. 5, can be obtained by double exposure at an angle of 120° , so that the light (sA) regions are regular-hexagonally packed and the rest are sB regions. The sA regions are set to strongly prefer the A blocks, i.e., $\alpha_{sA} = 2$. The stripe width is set along the x and y directions to $\omega_{sx} = 7$ and $\omega_{sy} = 8$, respectively; these values are commensurate with both the dimensions and the hexagonal packing of cylinders in the bulk. The film thickness is again fixed at $D = 28(\approx \sqrt{3}L_0)$.

[0040] Fig. 9 shows contour plots of the two-dimensional order parameter profiles $\langle \rho_A(x, y) - \rho_B(x, y) \rangle$ and $\langle \rho_A(x, z) - \rho_B(x, z) \rangle$ for the morphology between a lower hexagonally patterned substrate and an upper sH surface. It is seen that perpendicular cylinders registered with the substrate pattern form throughout the entire film. The maximum values of $\langle \rho_A(x, y) - \rho_B(x, y) \rangle$ are about 0.7. The long-range ordering of perpendicular cylinders is successfully induced by the hexagonally

patterned substrate. In this case the hexagonal pattern is transposed with respect to those obtained in previous cases, i.e., we have a staggered packing of cylinder layers in the y-z plane. Therefore, $\langle \rho_A(x,z) - \rho_B(x,z) \rangle$ is similar to the quantity $\langle \rho_A(y,z) - \rho_B(y,z) \rangle$ and $\langle \rho_A(y,z) - \rho_B(y,z) \rangle$ now exhibits small variations around -0.35. Although the sA regions are rhombus in this case, the A domains shown in the figure of $\langle \rho_A(x,y) - \rho_B(x,y) \rangle$ are still circular. This implies that the detailed shape of the sA regions is not crucial; instead, the arrangement of the sA regions is more important. The patterned substrate obtained by intersecting three equally spaced beams of light, i.e., spots of constructive interference in a hexagonal array, would work even better if the spacing between the spots is commensurate with the bulk period.

[0041] It is thus seen that both perpendicular and parallel orientations of the cylinders can be obtained by tuning the alternating stripe preference for the two blocks. The long-range ordering of perpendicular cylinders can be induced by a stripe-patterned substrate. An even better ordering can be obtained by employing a hexagonally patterned substrate commensurate with perpendicular cylinders having the same dimensions and packing as in the bulk.

[0042] The following are examples for purposes of illustrating the invention. Chemical gratings were patterned on SA films of OTS using EUV-IL with periods from 1400 to 60 nm. The behavior of films of P(S-b-MMA) on these surfaces was studied as a function of the ratio of L_s to L_o . For $L_s > L_o$, the surface patterns are transferred into the polymer film resulting in height variations on the surface. For $L_s = L_o$, the surface patterns are amplified by perpendicular lamellae. The two regimes of

behavior are discussed in terms of the lamellar structure and orientation in the polymer films.

[0043] Materials. Polished 100 mm diameter silicon (100) wafers were purchased from Tygh Silicon and used as substrates for deposition of films. Octadecyltrichlorosilane ($\text{CH}_3(\text{CH}_2)_{17}\text{SiCl}_3$, 95%) was purchased from Gelest and was used as received. Toluene (99.8%, anhydrous), and chloroform (99 + %, anhydrous) were purchased from Aldrich and were used without further purification. Symmetric poly(styrene- *block*-methyl methacrylate) block copolymers were purchased from Polymer Source Inc. Two molecular weights of P(S- *b*-MMA) were used in our experiments: (1) number-average molar mass = 51 200 g/mol, polydispersity = 1.06, styrene volume fraction = 0.48, and L_o is about 30 nm; (2) number-average molar mass = 143 500 g/mol, polydispersity = 1.09, styrene volume fraction = 0.51, and L_o is about 66 nm.

[0044] Preparation and Characterization of SA Films of OTS. The silicon wafers were cleaned by immersion in a piranha solution (7:3 (v:v) of 98% H_2SO_4 /30% H_2O_2) at 90 °C for 30 min. The silicon wafers were immediately rinsed with deionized water (resistivity $\geq 18 \text{ M}\Omega/\text{cm}$) several times and were blown dry with nitrogen. The cleansed substrates were immersed in a 0.1 % (v/v) solution of OTS in toluene in a glovebox with a nitrogen atmosphere. The typical immersion times used here ranged from 24 to 30 h. After the substrates were removed from the silane solution, they were rinsed with chloroform for approximately 30 s, and excess chloroform was allowed to evaporate. The films were rinsed with absolute ethanol and were dried under a stream of nitrogen.

Advancing contact angles of deionized water on OTS were measured using a Rame ´-Hart goniometer, and the typical value was about $105 \pm 3^\circ$. It has been shown that films of P(S- *b*-MMA) on the surface of SA films of OTS deposited under identical conditions exhibited symmetric wetting behavior after annealing at 180° C for 24 h.

[0045] Patterning of SA Films of OTS by EUV Interferometric Lithography. OTS was exposed to EUV radiation ($\lambda = 13.4$ nm) radiation using the EUV interferometer system at the Center for Nanotechnology in Madison, WI, discussed further below. The exposures were carried out in a chamber with a pressure of 100 mTorr of oxygen. The intensity of the incident radiation to the surface of SA films was about 10 mW/cm². The period of the fringe pattern for all exposures was verified by patterning UV6 photoresist (Shipley) after the system was configured with a particular geometry. Metrology of the photoresist was performed using scanning electron microscopy (Hitachi 6180 CD). The line and space structures of photoresist were often not exactly symmetric, as is the latent image (the interference pattern), but the period does not depend on symmetry and could be accurately determined by averaging over a large number of structures.

[0046] Deposition of Diblock Copolymer on Patterned OTS. Thin films of P(S-*b*-MMA) were deposited onto patterned OTS substrates by spin-coating from dilute solutions (2% w/w) of the copolymers in toluene. Films were spun at rates from 2500 to 3000 rpm for 60 s. The initial thicknesses of the films were determined using a Rudolf Research/Auto EL II ellipsometer using a He-Ne laser ($\lambda = 632.8$ nm) at an incident angle of 70° relative to the surface normal of the substrates. The use of the ellipsometer to measure the thicknesses of the P(S-*b*-MMA) films required

an assumption about the index of refraction, n , for the microphase-separated material. We assume n was the same as for polystyrene, and the results were consistent with measurements using a profilometer. The polymer films were annealed at 180° C in a vacuum oven for 24 h. After annealing, the films were investigated using atomic force microscopy (AFM) and transmission electron microscopy (TEM).

[0047] The surface topography of the polymer films was characterized using AFM. AFM measurements were performed in air in both contact mode and tapping mode with a Nanoscope III MultiMode system (Digital Instruments). In tapping mode, both topography and phase image were obtained simultaneously. The typical imaging force in contact mode was on the order of 10^{-9} N. We used both oxide-sharpened silicon nitride tips (radii = 5-40 nm, Digital Instruments) and carbon nanotips (radii < 5 nm, Piezomax Technologies, Inc.) to image the topography of the polymer surface.

[0048] The internal structure of the films was studied using TEM. TEM was performed on a JEOL 200CX at 200 kV in the bright field mode at the Materials Science Center at the University of Wisconsin-Madison. Samples were imaged in plane-view. A layer of carbon (ca. 20 nm thick) was evaporated onto the surface of films and then covered with a 25% aqueous solution of poly-(acrylic acid) (PAA). After the sample was dried in air overnight, the P(S-*b*-MMA)-carbon-PAA composite was peeled off the substrate and floated on deionized water with the PAA side down. After the PAA layer dissolved, the floating film was collected onto TEM grids. The films were then exposed to the vapor of the RuO₄ solution for 15 min. The RuO₄ selectively stains the PS block and provides contrast in electron density.

[0049] A schematic of the EUV interferometer exposure system utilized for the foregoing example is shown in Fig. 10. An Au-coated polished silicon wafer 30 (prepared by vacuum deposition with a root-mean-square roughness <0.32 nm) was used as a Lloyd's mirror set at an angle θ to the EUV beam 31 from a radiation source 32 (e.g., a synchrotron light source) to reflect part of an incident beam at grazing incidence and interfere with the direct beam at the sample plane. The fringe period is given by $\lambda/(2 \sin \theta)$ where θ is the angle of incidence with the Lloyd's mirror. The theoretical limit is 6.7 nm for the minimum printable period for incident radiation with a wavelength of 13.4 nm. A silicon wafer 34 with an imaging layer 35 of OTS thereon is placed at the downstream end of the mirror 30 so as to irradiate the layer 35 with the directly incident beam 31 from the source and a beam 37 reflected from the mirror 30 which are incident on the imaging layer 35 at an angle to each other to form interference fringe patterns. The number of fringes depends on the spatial and temporal coherence of the source. The spatial coherence depends on the size of the light source and distance from the source. In the experimental setup, temporal coherence ultimately limits the number of fringes, and the source can be considered to be spatially coherent for practical purposes. The finite temporal coherence limits the allowed optical path difference between the direct and reflected beams for producing fringes. The number of fringes, m , is proportional to $\lambda/\Delta\lambda$. The interferometer can be operated with or without a monochromator (not shown) in the path of the beam before the mirror. With the monochromator, the beam intensity is low, but $\lambda/\Delta\lambda$ is approximately 1000. In this mode, approximately 1000 fringes were produced. If the fringe period was 40 nm, for example, the width of the patterned area observed in patterns of photoresist was 40 μm . Without the

monochromator, the number of the fringes produced is 15-20 ($\lambda/\Delta\lambda \approx 15-20$), but the intensity of the beam is approximately 60 times greater than that of the monochromatic beam. Because of differences in sensitivity and contrast between photoresist and OTS imaging layers, the number of fringes that were observed in patterned photoresist was significantly greater than the number of fringes that were observed on patterned OTS. Exposures of OTS with grating periods of about 60 nm were performed without the monochromator so as to reduce the exposure times to approximately 50-60 s compared to about 1 h with the monochromator. The length of the exposed area corresponded to the width of the beam, about 5 mm. The 30 nm features on the patterned SA films of OTS with the smallest grating periods are the smallest reported features on SA films of alkylsiloxanes patterned using a parallel patterning technique.

[0050] From an AFM image of the surface of a P(S-*b*- MMA) film after it was deposited and annealed on OTS that had been exposed in the EUV interferometer, the period of the fringe pattern, L_s , was found to be 900 nm. The initial film thickness of the block copolymer was 66 ± 2 nm ($2.2L_0$). With knowledge of the initial film thickness and L_0 , the formation of topography on the surface of the film and the type of topography were used to determine the wetting of the block copolymer at the substrate. For the initial thickness of $2.2L_0$, island formation was indicative of symmetric wetting, and hole formation was indicative of asymmetric wetting. Three different regions were observed on this sample. The left side of the surface was unexposed because it was in the shadow of the mirror. Islands with heights of about 30 nm (L_0) were observed in this region, indicating symmetric wetting of the block copolymer with the PS block at the polymer-substrate interface and at the free surface. The

right side of the surface was uniformly exposed because this region is outside the area where coherent fringes are produced. Holes with depths of about 30 nm were observed in the exposed region, indicating asymmetric wetting of the block copolymer. In this case, the PMMA block preferentially wet the polymer-substrate interface, and PS was present at the free surface. On the patterned region in the middle, the topography of the block copolymer film replicated the period of the fringes of the EUV exposure. AFM measurements showed that the pattern period was 900 nm, and the difference in height between adjacent regions was 15 nm.

[0051] These results may be interpreted as follows. Exposure of OTS to X-rays results in the incorporation of oxygen-containing functional groups on the surface of the film. Primary and secondary electrons generated by the interaction of the X-rays with the substrate are primarily responsible for the photochemical reactions. The chemical modification of OTS exposed to EUV radiation is expected to follow the same mechanism as that for X-ray exposures. The wetting behavior of P(S-*b*-MMA) films on OTS-covered substrates can be tuned from symmetric to neutral to asymmetric wetting with increasing dose of x-rays. The transitions in wetting behavior were correlated to relative values of interfacial energy for the PS and PMMA blocks on these surfaces. The wetting behavior observed on OTS exposed to EUV radiation follows the same trends: symmetric wetting was observed on unexposed OTS or OTS exposed to low doses, and asymmetric wetting was observed on OTS exposed to high doses. The topography observed in the middle regions is identical to that observed on OTS patterned with X-ray lithography with dimensions of 150-1000 nm. Adjacent exposed and unexposed regions exhibited asymmetric and symmetric wetting,

respectively, and the block copolymer film differed in height by 15 nm ($\frac{1}{2} L_0$) across adjacent regions. The height difference of $\frac{1}{2} L_0$ corresponded to the difference in quantized thickness between symmetric and asymmetric wetting behavior.

[0052] AFM images of the surface of P(S-*b*-MMA) films after they were annealed on OTS that had been patterned with EUV interferometer with periods of 240 nm and 120 nm showed that the period of the fringe pattern was replicated with great fidelity by the undulating topography of the polymer films. The difference in height between exposed and unexposed regions for both cases was less than 15 nm ($\frac{1}{2} L_0$). To investigate the decrease in height difference with decreasing pattern dimensions, we configured the EUV interferometer to produce Fresnel diffraction fringes. The difference in height between adjacent regions, Δh , decreased from 15 to 3-4 nm, as L_s decreased from about 1410 nm (about 47 L_0) to 240 nm (4 L_0 , $L_0 = 30$ nm).

[0053] As the period of the interference pattern fringes with which the OTS was exposed approached the bulk lamellar period L_0 of the block copolymer, a different behavior was observed. An AFM phase image was made of P(S-*b*-MMA) film after it was annealed on an OTS surface that had been exposed using the EUV interferometer configured to produce about 60 nm fringe periods. The initial film thickness was about 60 nm (L_0). AFM images of the topography of the polymer films revealed that surface roughness was on the order of 1 nm, but no pattern in the roughness was observed. In phase images, however, a pattern was observed on the patterned region that matched the fringe period of the exposure. On the nonpatterned unexposed and exposed regions of the

samples, there was no evidence of alignment of the features in the phase image.

[0054] The foregoing experiment results show that if the period of the striped pattern in wetting behavior on the surface was greater than L_0 , the lamellae structure of P(S-*b*-MMA) films was orientated parallel to substrate and exhibited topography that replicated the underlying pattern of the surface. The difference in height between adjacent regions had a maximum value of $\frac{1}{2} L_0$ and decreased as L_s approached L_0 . If the period of the surface patterns was commensurate with L_0 , and preferably within 20% of L_0 , the lamellae structure was oriented perpendicular to the substrate and amplified the pattern of the imaging layer. Guided self-assembly of lamellae in block copolymer films was observed over macroscopic dimensions.

[0055] It is understood that the invention is not confined to the embodiments set forth herein as illustrative, but embraces all such forms thereof as come within the scope of the following claims.